

LOW DROP OR-ing POWER SCHOTTKY DIODE

MAIN PRODUCT CHARACTERISTICS

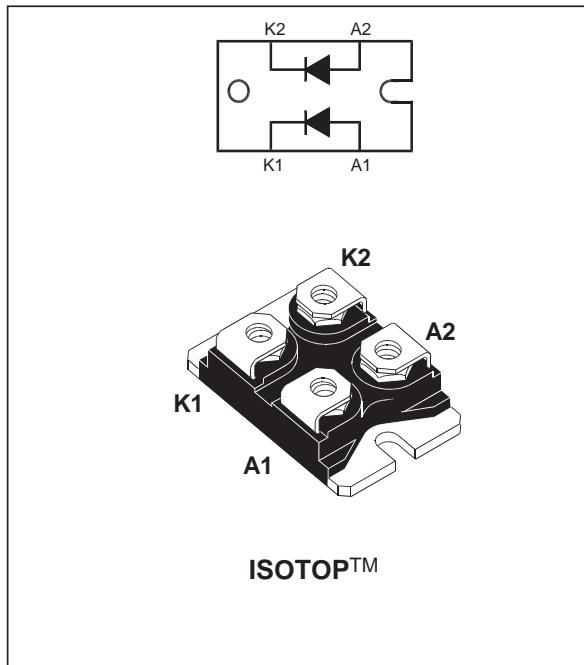
I_{F(AV)}	2 x 60 A
V_{RRM}	15 V
T_j (max)	125 °C
V_F (max)	0.31 V

FEATURES AND BENEFITS

- VERY LOW DROP FORWARD VOLTAGE FOR LESS POWER DISSIPATION AND REDUCED HEATSINK
- INSULATED PACKAGE:
Insulated voltage = 2500 V_(RMS)
Capacitance = 45 pF
- AVALANCHE CAPABILITY SPECIFIED

DESCRIPTION

Dual Schottky rectifier suited for Switched Mode Power Supplies and DC to DC power converters. Packaged in ISOTOP™, this device is especially intended for use as an OR-ing diode in fault tolerant power supply equipments.



ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter	Value	Unit
V _{RRM}	Repetitive peak reverse voltage	15	V
I _{F(RMS)}	RMS forward current	160	A
I _{F(AV)}	Average forward current	60	A
I _{FSM}	Surge non repetitive forward current	1200	A
I _{RRM}	Repetitive peak reverse current	2	A
P _{ARM}	Repetitive peak avalanche power	72030	W
T _{stg}	Storage temperature range	- 65 to + 150	°C
T _j	Maximum operating junction temperature	125	°C
dV/dt	Critical rate of rise of reverse voltage	10000	V/μs

* : $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th}(j - a)}$ thermal runaway condition for a diode on its own heatsink

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th}(j-c)$	Junction to case	Per diode	0.45
		Total	0.28
$R_{th}(c)$	Coupling	0.1	

STATIC ELECTRICAL CHARACTERISTICS (per diode)

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
I_R *	Reverse leakage current	$T_j = 100^\circ\text{C}$	$V_R = 5\text{V}$		450		mA
		$T_j = 25^\circ\text{C}$	$V_R = 12\text{V}$			22	mA
		$T_j = 100^\circ\text{C}$		0.7	2.2		A
V_F *	Forward voltage drop	$T_j = 25^\circ\text{C}$	$I_F = 60\text{ A}$			0.43	V
		$T_j = 125^\circ\text{C}$	$I_F = 60\text{ A}$	0.27	0.31		

Pulse test : * $t_p = 380\ \mu\text{s}$, $\delta < 2\%$

To evaluate the conduction losses use the following equation :

$$P = 0.18 \times I_F(\text{AV}) + 2.2 \times 10^{-3} \times I_F^2(\text{RMS})$$

Fig. 1: Average forward power dissipation versus average forward current (per diode).

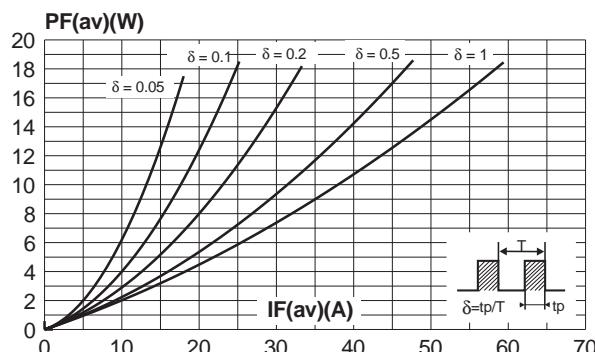


Fig. 2: Average forward current versus ambient temperature ($\delta = 1$) (per diode).

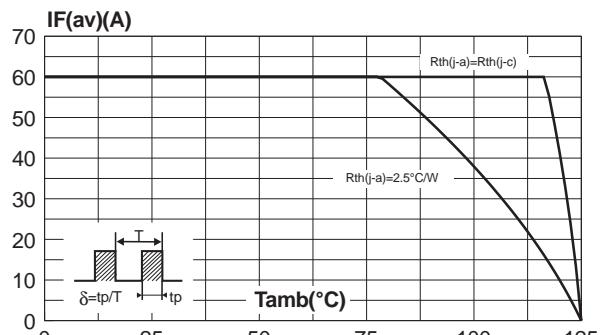


Fig. 3: Normalized avalanche power derating versus pulse duration.

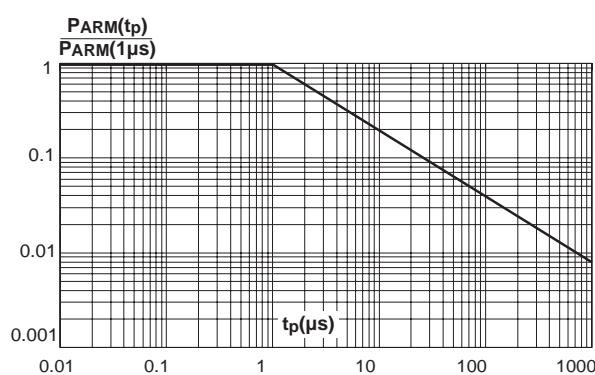


Fig. 4: Normalized avalanche power derating versus junction temperature.

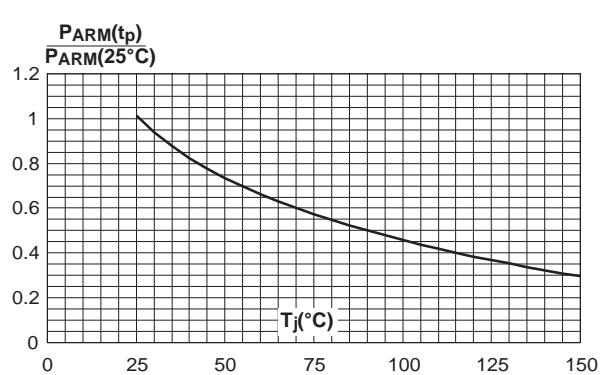


Fig. 5: Non repetitive surge peak forward current versus overload duration (maximum values per diode).

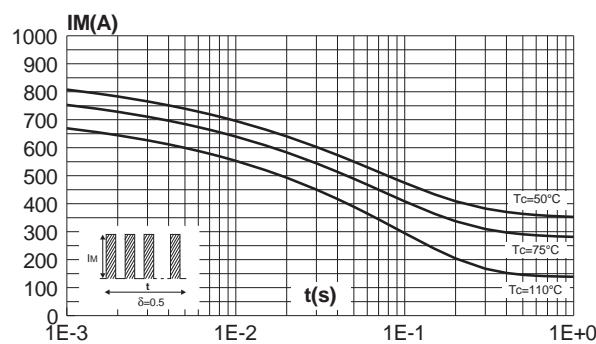


Fig. 6: Relative variation of thermal impedance junction to case versus pulse duration.

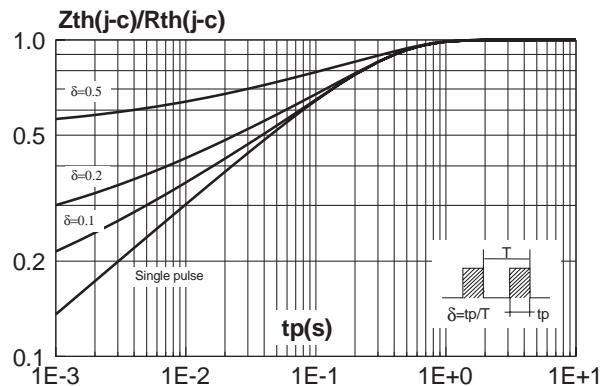


Fig. 7: Reverse leakage current versus reverse voltage applied (typical values per diode).

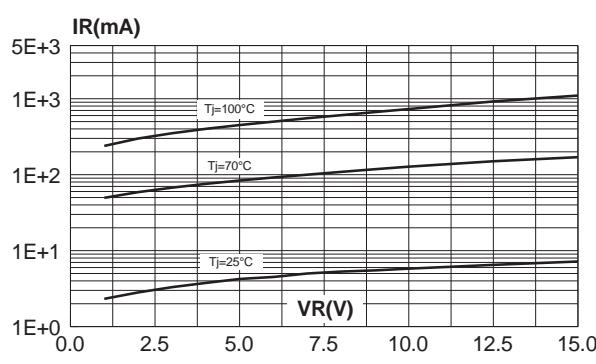


Fig. 8: Junction capacitance versus reverse voltage applied (typical values per diode).

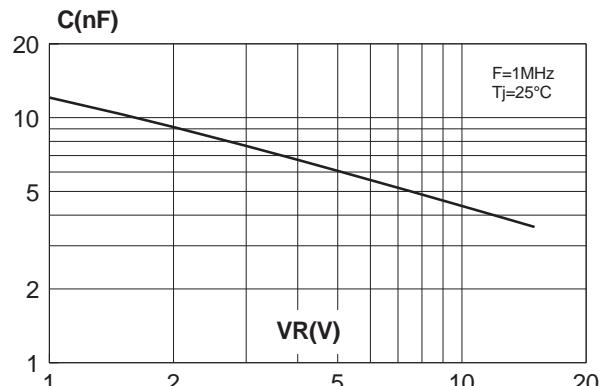
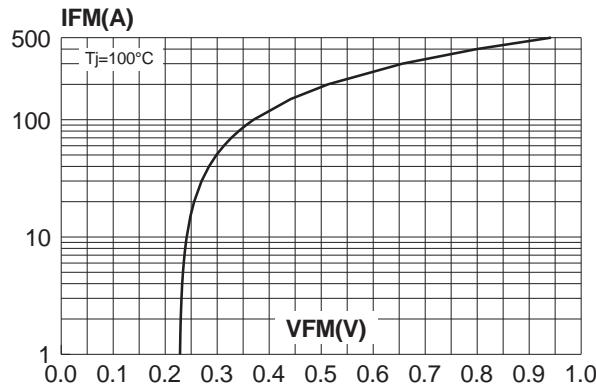


Fig. 9: Forward voltage drop versus forward current (maximum values per diode).



STPS120L15TV

PACKAGE MECHANICAL DATA ISOTOP

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	11.80	12.20	0.465	0.480
A1	8.90	9.10	0.350	0.358
B	7.8	8.20	0.307	0.323
C	0.75	0.85	0.030	0.033
C2	1.95	2.05	0.077	0.081
D	37.80	38.20	1.488	1.504
D1	31.50	31.70	1.240	1.248
E	25.15	25.50	0.990	1.004
E1	23.85	24.15	0.939	0.951
E2	24.80 typ.		0.976 typ.	
G	14.90	15.10	0.587	0.594
G1	12.60	12.80	0.496	0.504
G2	3.50	4.30	0.138	0.169
F	4.10	4.30	0.161	0.169
F1	4.60	5.00	0.181	0.197
P	4.00	4.30	0.157	0.69
P1	4.00	4.40	0.157	0.173
S	30.10	30.30	1.185	1.193

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS120L15TV	STPS120L15TV	ISOTOP	28g (without screws)	10	Tube

- Cooling method: by conduction (C)
- Recommended torque value : 1.3 N.m.
- Maximum torque value: 1.5 N.m.
- Epoxy meets UL94,V0

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